

# INTERNATIONAL STANDARD

## NORME INTERNATIONALE



**Function blocks (FB) for process control and electronic device description  
language (EDDL) –  
Part 4: EDD interpretation**

**Blocs fonctionnels (FB) pour les procédés industriels et le langage de  
description électronique de produit (EDDL) –  
Partie 4: Interprétation EDD**



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## INTERNATIONAL ELECTROTECHNICAL COMMISSION

**FUNCTION BLOCKS (FB) FOR PROCESS CONTROL AND  
ELECTRONIC DEVICE DESCRIPTION LANGUAGE (EDDL) –****Part 4: EDD interpretation**

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This third edition cancels and replaces IEC TR 61804-4 published in 2006. This edition constitutes a technical revision.

This edition includes the following significant technical changes with respect to the previous edition:

- New paragraph:
  - EDDL data description
  - EDDL METHOD programming and usage of builtins
  - Edit session
  - Offline and online configuration

- EDDL communication description
- Enhancements in paragraph EDDL user interface descriptions

The text of this standard is based on the following documents:

FDIS	Report on voting
65E/465/FDIS	65E/481/RVD

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This publication has been drafted in accordance with the ISO/IEC Directives, Part 2.

A list of all parts in the IEC 61804 series, published under the general title *Function blocks (FB) for process control and electronic device description language (EDDL)*, can be found on the IEC website.

Future standards in this series will carry the new general title as cited above. Titles of existing standards in this series will be updated at the time of the next edition.

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## INTRODUCTION

This part of IEC 61804 was developed using material from FDI Cooperation LLC (Foundation™ Fieldbus<sup>1</sup>, HART®<sup>2</sup> Communication Foundation (HCF), PROFIBUS™<sup>3</sup> Nutzerorganisation e.V. (PNO)), OPC Foundation (OPCF) and FDT Group. IEC 61804 has the general title "Function blocks (FB) for process control and Electronic Device Description Language (EDDL)".

This edition does not reflect many of the various rules defined by the different communication foundations, however it is not a complete representation of those rules defined by each of the communication foundations today. Therefore, an EDD application and EDD developer will need to rely on both IEC 61804-4 and the respective communication foundation documents (e.g. specifications, test requirements, test cases) to develop a conformant application that will meet foundation registration requirements.

Conformity assessment of an EDD application is the responsibility of the respective communication foundations. In cases of any ambiguity, the rules of the respective communication foundations apply.

This part of IEC 61804

- contains an overview of the use of EDDL;
- provides examples demonstrating the use of the EDDL constructs;
- shows how the use cases are fulfilled; and
- shows the proper EDD application interpretation for each example.

This part of IEC 61804 is not an EDDL tutorial and is not intended to replace the EDDL specification.

Instructions are provided for the EDD application, which describe what will be performed without prescribing the technology used in the host implementation. For example, the FILE construct describes data that is stored by the EDD application on behalf of the EDD. The FILE construct does not specify how the data is stored. The EDD application can use a database, a flat file, or any other implementation it chooses.

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# FUNCTION BLOCKS (FB) FOR PROCESS CONTROL AND ELECTRONIC DEVICE DESCRIPTION LANGUAGE (EDDL) –

## Part 4: EDD interpretation

### 1 Scope

This part of IEC 61804 specifies EDD interpretation for EDD applications and EDDs to support EDD interoperability. This document is intended to ensure that field device developers use the EDDL constructs consistently and that the EDD applications have the same interpretations of the EDD. It supplements the EDDL specification to promote EDDL application interoperability and improve EDD portability between EDDL applications.

### 2 Normative references

The following documents, in whole or in part, are normatively referenced in this document and are indispensable for its application. For dated references, only the edition cited applies. For undated references, the latest edition of the referenced document (including any amendments) applies.

IEC 61784-1, *Industrial communication networks – Profiles – Part 1: Fieldbus profiles*

IEC 61784-2, *Industrial communication networks – Profiles – Part 2: Additional fieldbus profiles for real-time networks based on ISO/IEC 8802-3*

IEC 61804-2, *Function blocks (FB) for process control – Part 2: Specification of FB concept*

IEC 61804-3<sup>4</sup>, *Function blocks (FB) for process control and Electronic device description language (EDDL) – Part 3: EDDL syntax and semantics*

IEC 61804-5<sup>5</sup>, *Function blocks (FB) for process control and Electronic device description language (EDDL) – Part 5: EDDL Builtin library*

ISO/IEC 10918 (all parts), *Information technology – Digital compression and coding of continuous-tone still images*

ISO/IEC 15948, *Information technology – Computer graphics and image processing – Portable Network Graphics (PNG): Functional specification*

### 3 Terms, definitions, abbreviated terms, acronyms and conventions

For the purposes of this document, the terms and definitions given in IEC 61804-3 as well as the following apply.

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<sup>4</sup> To be published.

<sup>5</sup> To be published.